

RGTH00TK65D

650V 50A Field Stop Trench IGBT

V _{CES}	650V
I _{C(100°C)}	21A
V _{CE(sat) (Typ.)}	1.6V@I _C =50A
P_D	72W

Features

- 1) Low Collector Emitter Saturation Voltage
- 2) High Speed Switching
- 3) Low Switching Loss & Soft Switching
- 4) Built in Very Fast & Soft Recovery FRD (RFN - Series)
- 5) Pb free Lead Plating; RoHS Compliant

Applications

PFC

UPS

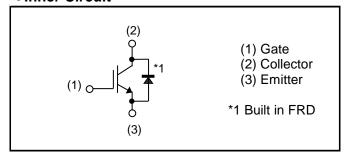
Power Conditioner

ΙH

Outline



●Inner Circuit



Packaging Specifications

	Packaging	Tube
	Reel Size (mm)	-
Typo	Tape Width (mm)	-
Туре	Basic Ordering Unit (pcs)	450
	Packing Code	C11
	Marking	RGTH00TK65D

◆Absolute Maximum Ratings (at T_C = 25°C unless otherwise specified)

Parameter		Symbol	Value	Unit
Collector - Emitter Voltage		V _{CES}	650	V
Gate - Emitter Voltage		V_{GES}	±30	V
Callagton Cumant	T _C = 25°C	I _C	35	А
Collector Current	T _C = 100°C	I _C	21	А
Pulsed Collector Current		I _{CP} *1	200	А
Diode Forward Current	T _C = 25°C	I _F	34	А
	T _C = 100°C	I _F	19	А
Diode Pulsed Forward Current		I _{FP} *1	200	А
Dawar Dissination	T _C = 25°C	P _D	72	W
Power Dissipation	T _C = 100°C	P _D	36	W
Operating Junction Temperature		T _j	-40 to +175	°C
Storage Temperature		T _{stg}	-55 to +175	°C

^{*1} Pulse width limited by $T_{jmax.}$

●Thermal Resistance

Parameter	Symbol	Values			Linit
Farameter		Min.	Тур.	Max.	Unit
Thermal Resistance IGBT Junction - Case	$R_{\theta(j-c)}$	-	-	2.07	°C/W
Thermal Resistance Diode Junction - Case	$R_{\theta(j-c)}$	-	-	3.09	°C/W

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
raiaillelei			Min.	Тур.	Max.	Offic
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_C = 10 \mu A, V_{GE} = 0 V$	650	1	-	V
Collector Cut - off Current	I _{CES}	$V_{CE} = 650V, V_{GE} = 0V$	ı	1	10	μΑ
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, \ V_{CE} = 0V$	-	•	±200	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 34.7 \text{mA}$	4.5	5.5	6.5	V
Collector - Emitter Saturation Voltage	V _{CE(sat)}	$I_C = 50A$, $V_{GE} = 15V$ $T_j = 25$ °C $T_j = 175$ °C	-	1.6 2.1	2.1	V

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions		Unit		
			Min.	Тур.	Max.	Offic
Input Capacitance	C _{ies}	V _{CE} = 30V	-	2740	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$	-	106	-	pF
Reverse Transfer Capacitance	C _{res}	f = 1MHz	-	43	-	
Total Gate Charge	Q_g	V _{CE} = 300V	-	94	-	
Gate - Emitter Charge	Q_ge	I _C = 50A	-	22	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	31	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 50A, V_{CC} = 400V$	-	39	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	63	-	
Turn - off Delay Time	t _{d(off)}	T _j = 25°C	-	143	-	ns
Fall Time	t _f	Inductive Load	-	50	-	
Turn - on Delay Time	t _{d(on)}	$I_C = 50A, V_{CC} = 400V$	-	39	-	
Rise Time	t _r	$V_{GE} = 15V, R_G = 10\Omega$	-	63	-	20
Turn - off Delay Time	$t_{d(off)}$	T _j = 175°C	-	159	-	ns
Fall Time	t _f	Inductive Load	-	62	-	
		$I_C = 200A, V_{CC} = 520V$				
Reverse Bias Safe Operating Area	RBSOA	$V_P = 650 V, V_{GE} = 15 V$	FU	LL SQUA	RE	-
		$R_G = 60\Omega, T_j = 175^{\circ}C$				

●IGBT Electrical Characteristics (at T_j = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit
			Min.	Тур.	Max.	Offic
Diode Forward Voltage	V _F	$I_F = 30A$ $T_j = 25$ °C $T_j = 175$ °C	-	1.45 1.25	2.0	V
Diode Reverse Recovery Time	t _{rr}	I _F = 30A	-	54	1	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$ $T_j = 25^{\circ}C$	-	7.4	-	А
Diode Reverse Recovery Charge	Q _{rr}		-	0.22	-	μC
Diode Reverse Recovery Time	t _{rr}	I _F = 30A	-	225	1	ns
Diode Peak Reverse Recovery Current	I _{rr}	$V_{CC} = 400V$ $di_F/dt = 200A/\mu s$	-	12.8	-	А
Diode Reverse Recovery Charge	Q_{rr}	T _j = 175°C	-	1.60	-	μC

Fig.1 Power Dissipation vs. Case Temperature

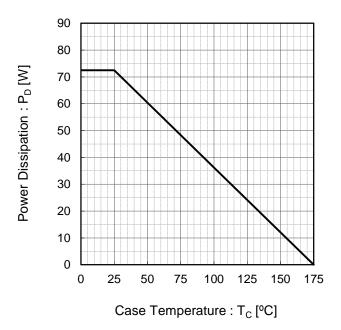
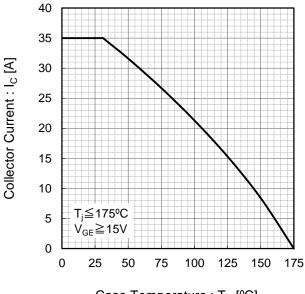


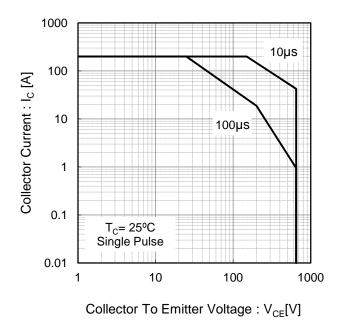
Fig.2 Collector Current vs. Case Temperature



Case Temperature : T_C [°C]

Fig.4 Reverse Bias Safe Operating Area

Fig.3 Forward Bias Safe Operating Area



Collector Current : I_C [A]

240 220 200 180 160 140 120 100 80 60 40 T_i≦175°C 20 V_{GE} =15V0 200 400 600 800 0

Collector To Emitter Voltage : $V_{CE}[V]$

Fig.5 Typical Output Characteristics

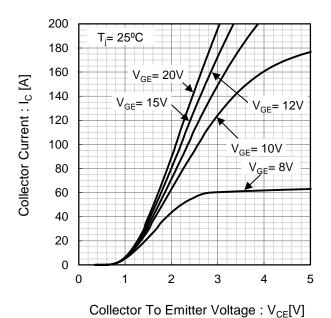
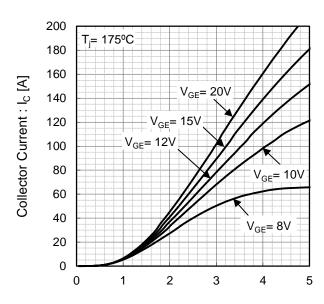


Fig.6 Typical Output Characteristics



Collector To Emitter Voltage : V_{CE}[V]

Fig.7 Typical Transfer Characteristics

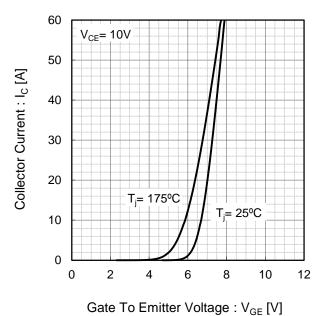
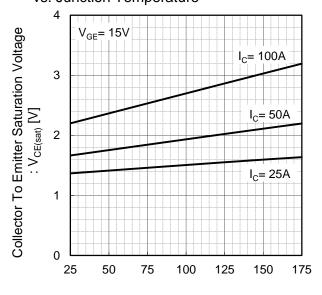


Fig.8 Typical Collector To Emitter Saturation Voltage vs. Junction Temperature



Junction Temperature : T_i [°C]

Fig.9 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage

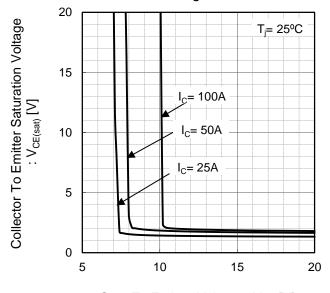
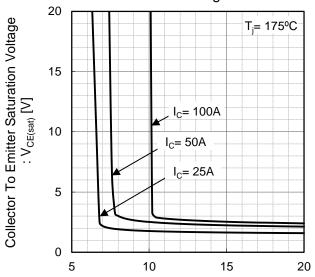


Fig.10 Typical Collector To Emitter Saturation Voltage vs. Gate To Emitter Voltage



Gate To Emitter Voltage: V_{GE} [V]

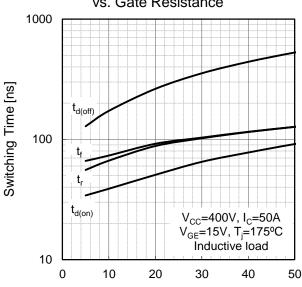
Gate To Emitter Voltage : V_{GE} [V]

vs. Collector Current $t_{d(off)}$ $t_{d(off)}$ $t_{d(on)}$ $v_{CC}=400V, V_{GE}=15V$ $R_{G}=10\Omega, T_{j}=175^{\circ}C$ Inductive load 0 10 20 30 40 50 60 70 80 90 100

Collector Current : I_C [A]

Fig.11 Typical Switching Time

Fig.12 Typical Switching Time vs. Gate Resistance



Gate Resistance : $R_G[\Omega]$

Fig.13 Typical Switching Energy Losses vs. Collector Current

10 E_{on} 0.1 E_{on} $V_{cc}=400V, V_{gE}=15V$ $E_{gE}=100, T_{jE}=175$ Inductive load

0.10

Collector Current: I_{c} [A]

Fig.14 Typical Switching Energy Losses vs. Gate Resistance 10 Switching Energy Losses [mJ] $\mathsf{E}_{\mathsf{off}}$ 1 E_{on} 0.1 V_{CC} =400V, I_{C} =50A V_{GE} =15V, T_{j} =175°C Inductive load 0.01 0 10 20 30 40 50 Gate Resistance : $R_G[\Omega]$

Fig.15 Typical Capacitance vs. Collector To Emitter Voltage 10000 Cies 1000 Capacitance [pF] Coes 100 Cres 10 f=1MHz $V_{GE}=0V$ T;=25°C 0.01 0.1 10 100 Collector To Emitter Voltage : V_{CE}[V]

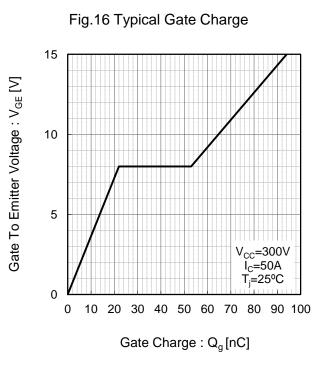


Fig.17 Typical Diode Forward Current vs. Forward Voltage 200 180 160 Forward Current : I_F [A] 140 120 100 80 60 T_i= 175°C 40 T_i= 25°C 20 0 3.5 0 0.5 1.5 2 2.5 3 Forward Voltage : V_F[V]

Fig.18 Typical Diode Reverse Recovery Time vs. Forward Current 400 V_{CC} =400V di_F/dt=200A/µs Reverse Recovery Time: t_{rr} [ns] Inductive load 300 T_i= 175°C 200 100 T_i= 25°C 0 10 20 30 40 50 0 Forward Current : I_F [A]

Fig.19 Typical Diode Reverse Recovery Current vs. Forward Current

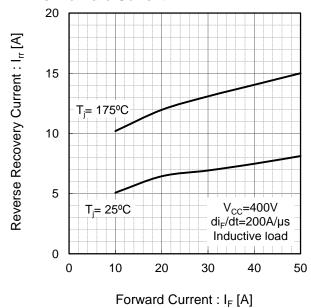


Fig.20 Typical Diode Reverse Recovery Charge vs. Forward Current

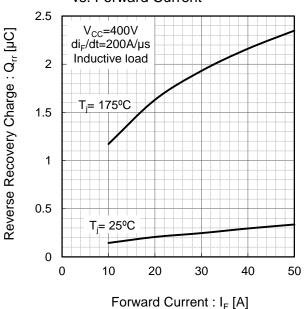


Fig.21 IGBT Transient Thermal Impedance

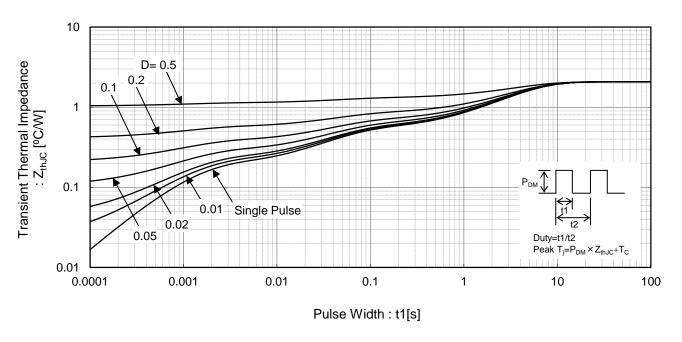
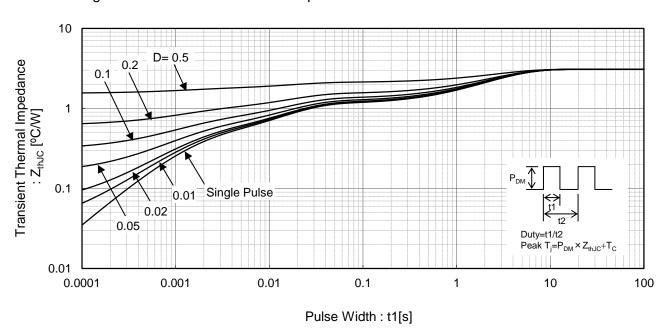


Fig.22 Diode Transient Thermal Impedance



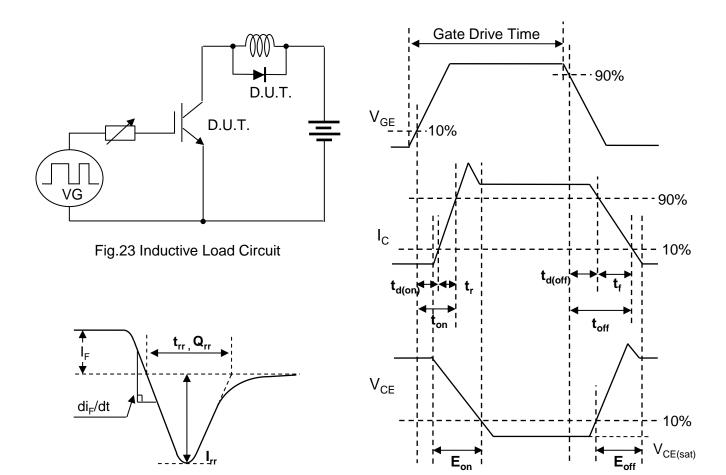


Fig.25 Diode Reverce Recovery Waveform

Fig.24 Inductive Load Waveform

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